

# Current-Voltage Relation

- For  $V_{GS} > V_{TN}$  and *small*  $V_{DS}$ :

$$I_D = k_N \left( V_{GT} V_{DS} - V_{DS}^2 / 2 \right)$$

$$V_{GT} = V_{GS} - V_{TN} = \textit{Gate overdrive}$$

$$k_N = (W/L) k'_N$$

= *Device transconductance parameter*

$$W/L = \textit{Aspect ratio}$$

$$k'_N = \mu_n C'_{ox}$$

= *Process transconductance parameter*

$\mu_n$  = *Channel electron mobility*

- For *small*  $V_{DS}$ , the  $V_{DS}^2$  term can be *neglected*
  - $I_D$  changes *linearly* with  $V_{DS}$ 
    - *Linear* (or *Non-Saturation*) Region
- As  $V_{DS} \uparrow$ , the *restraining* effect of  $V_{DS}^2$  term  $\uparrow$ 
  - *Rate of increase* of  $I_D$  with  $V_{DS}$  *slows down*

- For *inversion channel* to exist at the *D end*,  
 $V_{GD}$  must be  $> V_{TN}$ 
  - $V_{DS}$  must be  $< V_{GT}$
- When  $V_{DS} = V_{GT}$ , the *channel* is said to be *pinched-off* at the *D end*, and  $I_D$  does not increase any more
- This value of  $V_{DS}$  is known as the *drain-to-source saturation voltage*  $V_{DS,sat}$ 
  - $V_{DS,sat} = V_{GT}$

- For  $V_{DS} > V_{DS,sat}$ , the *mode of operation* is known as *saturation*
- *Drain current in saturation:*

$$I_D = \frac{k_N}{2} V_{GT}^2$$

- *Obtained from the non-saturation  $I_D$  expression by substituting  $V_{DS} = V_{GT}$*
- *Note that  $I_D$  is independent of  $V_{DS}$*
- *Above equations are valid for  $V_{GT} > 3V_T$   
( $\sim 80\text{ mV}$  at room temperature)*

# The Complete LEVEL 0 Model

$$I_D = k_N \left( V_{GT} V_{DS} - V_{DS}^2 / 2 \right)$$

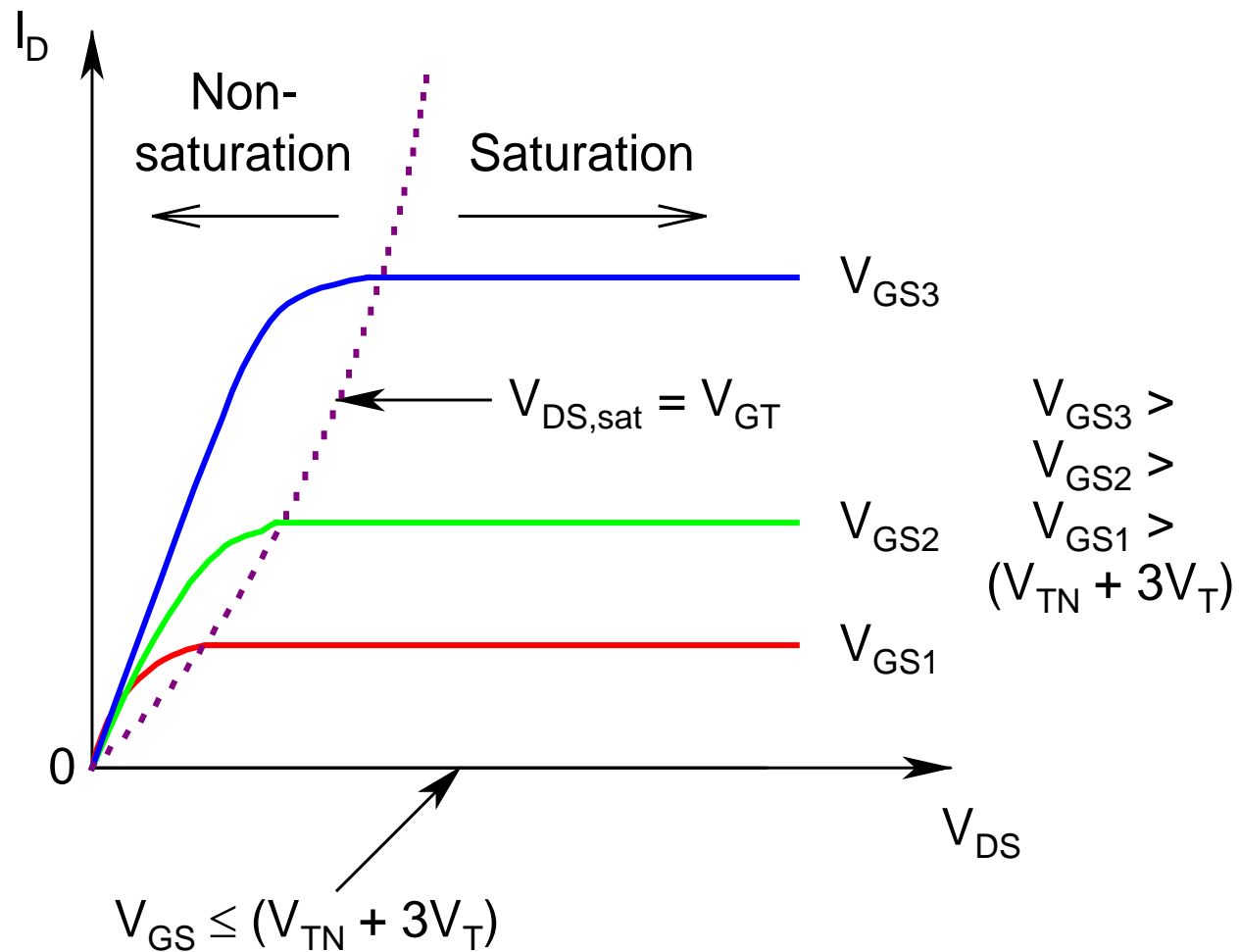
*(linear region -  $V_{GT} > 3V_T, V_{DS} < V_{GT}$ )*

$$= (k_N / 2) V_{GT}^2$$

*(saturation region -  $V_{GT} > 3V_T, V_{DS} \geq V_{GT}$ )*

$$= 0$$

*(cutoff region -  $V_{GT} \leq 3V_T, \text{ any } V_{DS}$ )*



## $I_D$ - $V_{DS}$ Characteristics